



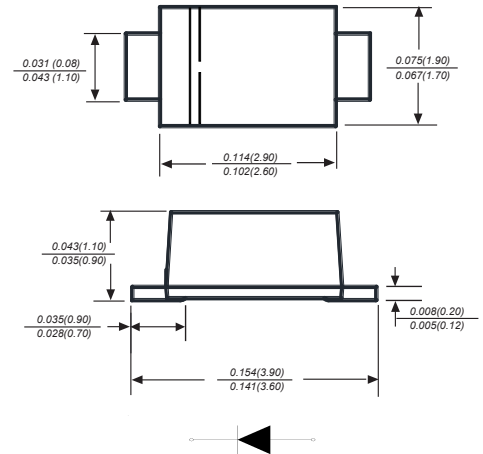
Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Metal silicon junction,majority carrier conduction
- ◆ Low power loss,high efficiency
- ◆ Built-in strain relief,ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed:
250 °C/10 seconds at terminals

Mechanical Data

Case : JEDEC SOD-123FL molded plastic body
Terminals : Solderable per MIL-STD-750,Method 2026
Polarity : Color band denotes cathode end Mounting
Position : Any
Weight : 0.0007 ounce, 0.02 grams

SOD-123FL



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25° C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz,resistive or inductive load,for capacitive load current derate by 20%.

Parameter	SYMBOLS	DSS34	UNITS
Marking Code			
Maximum repetitive peak reverse voltage	V_{RRM}	40	V
Maximum RMS voltage	V_{RMS}	28	V
Maximum DC blocking voltage	V_{DC}	40	V
Maximum average forward rectified current at TL(see fig.1)	I_{AV}	2.5	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	40	A
Maximum instantaneous forward voltage at 2.0A	V_F	0.55	V
Maximum DC reverse current $T_A=25^{\circ}C$ at rated DC blocking voltage $T_A=125^{\circ}C$	I_R	0.5 10.0	mA
Typical junction capacitance (NOTE 1)	C_J	220	pF
Typical thermal resistance (NOTE 2)	$R_{\theta JA}$	85.0	$^{\circ}C/W$
Operating junction temperature range	T_J	-55 to +125	$^{\circ}C$
Storage temperature range	T_{STG}	-55 to +150	$^{\circ}C$

Note:1.Measured at 1MHz and applied reverse voltage of 4.0V D.C.



Typical Characteristics

Fig.1 Forward Current Derating Curve

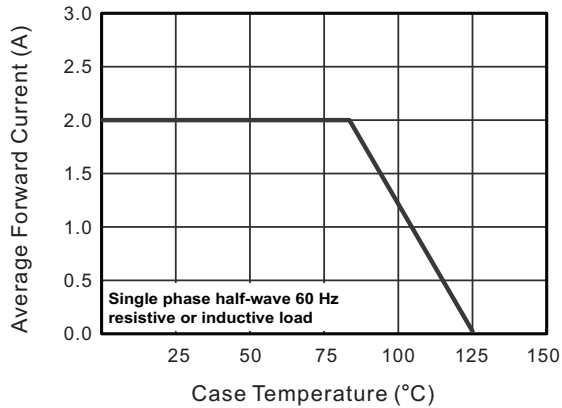


Fig.2 Typical Reverse Characteristics

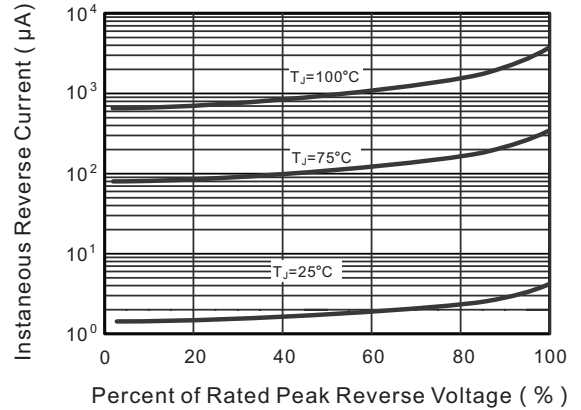


Fig.3 Typical Forward Characteristic

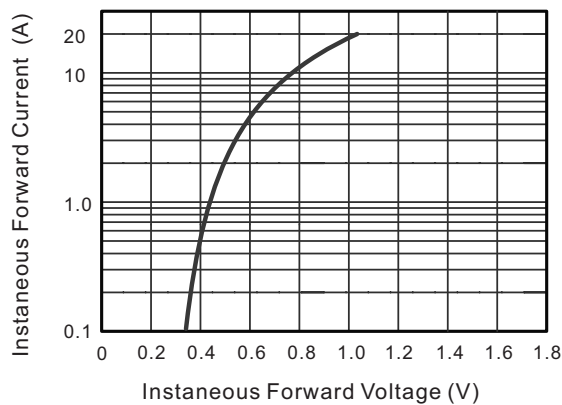


Fig.4 Typical Junction Capacitance

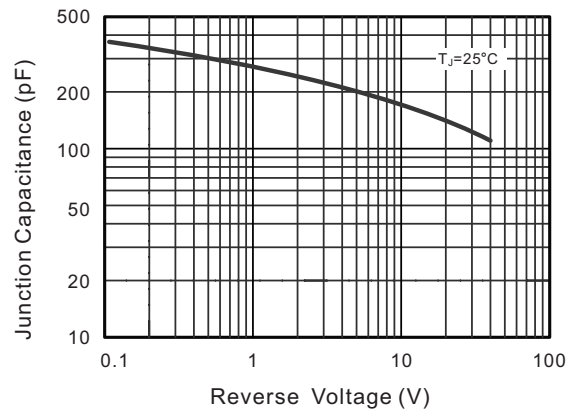


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

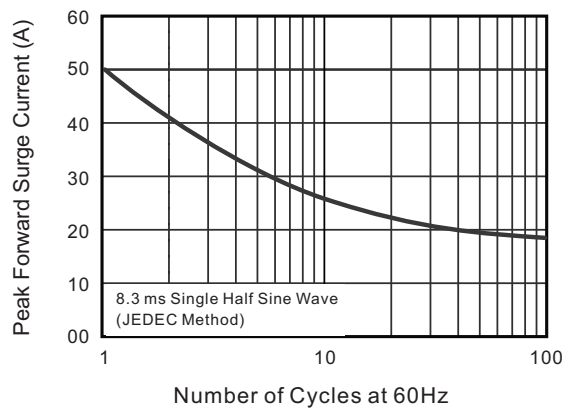


Fig.6- Typical Transient Thermal Impedance

